

TRADEMARK ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

ETAS ID: TM413045

SUBMISSION TYPE:	NEW ASSIGNMENT		
NATURE OF CONVEYANCE:	RELEASE OF SECURITY INTEREST		
CONVEYING PARTY DATA			
Name	Formerly	Execution Date	Entity Type
MB FINANCIAL BANK, N.A., AS ADMINISTRATIVE AGENT		12/29/2016	National Banking Association: ILLINOIS
RECEIVING PARTY DATA			
Name:	LAPMASTER GROUP HOLDINGS LLC		
Street Address:	501 WEST ALGONQUIN ROAD		
City:	MOUNT PROSPECT		
State/Country:	ILLINOIS		
Postal Code:	60056		
Entity Type:	Limited Liability Company: ILLINOIS		
Name:	LAPMASTER INTERNATIONAL, LLC		
Street Address:	501 WEST ALGONQUIN ROAD		
City:	MOUNT PROSPECT		
State/Country:	ILLINOIS		
Postal Code:	60056		
Entity Type:	Limited Liability Company: ILLINOIS		
Name:	BATES TECHNOLOGIES, LLC		
Street Address:	501 WEST ALGONQUIN ROAD		
City:	MOUNT PROSPECT		
State/Country:	ILLINOIS		
Postal Code:	60056		
Entity Type:	Limited Liability Company: ILLINOIS		
Name:	LAPMASTER WOLTERS LIMITED		
Street Address:	NORTH ROAD, LEE MILL INDUSTRIAL ESTATE		
Internal Address:	NR IVYBRIDGE		
City:	DEVON		
State/Country:	UNITED KINGDOM		
Postal Code:	PL21 9EN		
Entity Type:	Limited Liability Company: UNITED KINGDOM		
Name:	NHL SUB GMBH		
Street Address:	BUESUMER STRASSE 96		

OP \$215.00 0267871

City:	RENDSBURG
State/Country:	GERMANY
Postal Code:	24768
Entity Type:	Private Limited Liability Company: GERMANY
Name:	LAPMASTER WOLTERS GMBH
Street Address:	BUESUMER STRASSE 96
City:	RENDSBURG
State/Country:	GERMANY
Postal Code:	24768
Entity Type:	Private Limited Liability Company: GERMANY
Name:	FORMATEC HOLDING B.V.
Street Address:	NOBLESTRAAT 16
City:	GOIRLE
State/Country:	NETHERLANDS
Postal Code:	5051 DV
Entity Type:	Private Limited Liability Company: NETHERLANDS
Name:	LAPMASTER WOLTERS JAPAN KABUSHIKI KAISHA
Street Address:	12-29 ESAKA-CHO 1 CHROME, SUITASHI
City:	OSAKA
State/Country:	JAPAN
Postal Code:	564-0063
Entity Type:	Stock Company: JAPAN
Name:	LAPMASTER WOLTERS (SHENYANG) PRECISION MACHINERY CO., LTD.
Street Address:	3 A-2, RD 8
Internal Address:	SHENYANG ECONOMICAL AND TECHNOLOGICAL DEVELOPMENT ZONE
City:	SHENYANG
State/Country:	CHINA
Entity Type:	Company: CHINA

PROPERTY NUMBERS Total: 8

Property Type	Number	Word Mark
Registration Number:	0267871	MICROMATIC
Registration Number:	1939188	MICROSIZE
Registration Number:	2445942	BATES
Registration Number:	2842816	
Registration Number:	1147047	LAPMASTER
Registration Number:	0671371	LAPMASTER
Registration Number:	0671714	LAPMASTER

TRADEMARK

Property Type	Number	Word Mark
Registration Number:	0667703	LAPMASTER

CORRESPONDENCE DATA

Fax Number: 7037125050
Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.
Phone: 703-712-5352
Email: jmiller@mcguirewoods.com
Correspondent Name: Joyce Miller
Address Line 1: 1750 Tysons Blvd.
Address Line 2: Suite 1800
Address Line 4: Tysons, VIRGINIA 22102

NAME OF SUBMITTER:	Joyce Miller
SIGNATURE:	/Joyce Miller/
DATE SIGNED:	01/20/2017

Total Attachments: 13

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RELEASE OF PATENT AND TRADEMARK SECURITY AGREEMENT

THIS RELEASE dated as of December 29, 2016 (this “**Release**”) is made by MB FINANCIAL BANK, N.A., acting in its capacity as administrative agent (in such capacity, the “**Administrative Agent**”) under that certain Patent and Trademark Security Agreement, dated as of November 6, 2015 (the “**IP Security Agreement**”), by and among LAPMASTER GROUP HOLDINGS LLC, an Illinois limited liability company (the “**Borrower Agent**”), LAPMASTER INTERNATIONAL, LLC, an Illinois limited liability company (“**Lapmaster International**”), BATES TECHNOLOGIES, LLC, an Illinois limited liability company (“**Bates**”), LAPMASTER WOLTERS LIMITED (“**Lapmaster Wolters**”), LAPMASTER WOLTERS (SHENYANG) PRECISION MACHINERY CO., LTD. (“**Lapmaster Wolters (Shenyang)**”), NHL SUB GMBH (“**NHL**”), LAPMASTER WOLTERS GMBH (“**Lapmaster Wolters GmbH**”), FORMATEC HOLDING B.V. (“**Formatec**”), and LAPMASTER WOLTERS JAPAN KABUSHIKI KAISHA (“Lapmaster Wolters Japan”) and Administrative Agent. Borrower Agent, Lapmaster International, Bates, Lapmaster Wolters, Lapmaster Wolters (Shenyang), NHL, Lapmaster Wolters GmbH, Formatec, Lapmaster Wolters Japan are known as “**Grantors**” and each a “**Grantor**” under this release. The IP Security Agreement was recorded with the United States Patent and Trademark Office against certain patents and patent applications on November 10, 2015, at Reel 037080, Frame 0023 and against certain trademarks and trademark applications at Reel 5664, Frame 0725. Borrower Agent, Lapmaster International, and Bates are known as “**Borrowers**” and each a “**Borrower**” under this Release. The Patent and Trademark Security Agreement was entered into in connection with a Credit Agreement, dated as of November 6, 2015, made by Grantors (as amended, supplemented, restated, replaced and otherwise modified from time to time), and a certain Guaranty and Collateral Agreement, dated as of November 6, 2015, made by Grantors (as amended, supplemented, restated, replaced and otherwise modified from time to time, the “**Guaranty and Collateral Agreement**”).

WHEREAS, pursuant to the IP Security Agreement, each Grantor granted to the Administrative Agent a continuing security interest in and to all of such Grantors’ right, title and interest in, to and under the following including, but not limited to:

- 1) Each registered trademark and trademark application for registration of Grantors, including, without limitation, each registered trademark and trademark application for registration of Grantors referred to in Schedule 1, together with any reissues, continuations or extensions thereof and all goodwill associated therewith;
- 2) Each license of a trademark to Grantors, including without limitation, each license of a trademark to Grantors listed on Schedule 1, together with all goodwill associated therewith;
- 3) All products and proceeds of the foregoing, including, without limitation, any claim by Grantors against third parties for past, present or future infringement of any trademark, including, without limitation, any trademark referred to in Schedule 1, any trademark issued pursuant to a trademark application referred to in Schedule 1 and

any trademark licensed under any trademark license listed on Schedule 1 (items 1-3 being herein collectively referred to as the “**Trademark Collateral**”);

- 4) Each patent and patent application of Grantors, including, without limitation, each patent and patent application of Grantors referred to in Schedule 2, together with any reissues, continuations, or extensions thereof;
- 5) Each license of a patent to Grantors, including, without limitation, each license of a patent to Grantors listed on Schedule 2;
- 6) All products and proceeds of the foregoing, including, without limitation, any claim by Grantors against third parties for past, present or future infringement of any patent, including, without limitation, any patent referred to in Schedule 2, any patent issued pursuant to a patent application referred to in Schedule 2, and any patent licensed under any patent license listed on Schedule 2 (items 4-6 being herein collectively referred to as the “**Patent Collateral**”).

WHEREAS, pursuant to that certain Copyright, Patent, Trademark and License Security Agreement, dated as of October 13, 2003, by and among Lapmaster International and Cole Taylor Bank, Lapmaster International granted to Cole Taylor Bank a continuing interest Lapmaster International’s copyrights, copyright agreements, copyright applications, patents, patent applications, trademarks, trademark applications, trade names, service marks, service mark applications, goodwill and certain licenses (the “**Cole Taylor Bank Collateral**”) including, without limitation, the registered trademarks of Lapmaster International referred to in Schedule 3. The Copyright, Patent, Trademark and License Security Agreement was recorded with the United States Patent and Trademark Office against certain trademarks and trademark applications on October 22, 2003, at Reel 002734, Frame 0381.

WHEREAS, Administrative Agent purchased Cole Taylor Bank and assumed Cole Taylor Bank’s rights and obligations under the Copyright, Patent, Trademark and License Security Agreement.

WHEREAS, the Grantors have requested and the Administrative Agent has agreed to provide a document suitable for recording in the United States Patent and Trademark Office evidencing and effecting the release, relinquishment and discharge of its security interest in the Trademark Collateral, the Patent Collateral, and the Cole Taylor Bank Collateral (the “**Released Collateral**”).

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, the Administrative Agent does hereby, (i) terminate the liens and security interest created under the IP Security Agreement and the Guaranty and Collateral Agreement in the Released Collateral, (ii) release its security interest in the Released Collateral, and (iii) discharge any and all rights, title and interest it has in and the security interest granted to Administrative Agent in the Released Collateral. Administrative Agent acknowledges that this Release may be filed along with other necessary documentation with the United States Patent and Trademark Office or any other governmental office to evidence the release granted herein. The

Administrative Agent will execute such further documents as deemed reasonably necessary by the Grantors to confirm and effect this Release.

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IN WITNESS WHEREOF, Administrative Agent has executed this Release as of the date first set forth above.

MB FINANCIAL BANK, N.A., as Administrative Agent


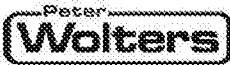

By: 




Name: Christopher Foltman
Title: Senior Vice President

116935-0013/133823869.4


TRADEMARK
REEL: 005974 FRAME: 0824



SCHEDULE 1: Trademarks and Trademark Applications

Trademark	Country	Filing Date	Serial No.	Reg. Date	Reg. No.	Status
LAPMASTER	Brazil	19.10.1959	002371740	19.10.1979	002371740	Registered
LAPMASTER	Canada	22.03.1954	224022	22.03.1954	UCA49501	Registered
MICROSIZE	Canada	17.12.1992	719049	18.03.1997	TMA472932	Registered
MICROHONE	Canada	28.06.1965	290382	11.02.1966	TMA143959	Registered
MICROSIZE	Canada	17.09.1956	237435	13.06.1958	TMA110490	Registered
TouchGrind	EU	11.10.2013	012216974	05.03.2014	012216974	Erteilt
LAPMASTER	EU	08.06.2004	3860939	19.10.2005	3860939	Registered
MICROSIZE	France	29.05.1995	95-573329	07.12.2004	95-573329	Cancelled
microLine	Germany	28.10.1991	W42347	01.10.1993	2 046 195	Registered
Peter Wolters (Logo) 	Germany	28.10.1991	W42348	04.05.1994	2 063 868	Registered
RangeCare	Germany	19.06.2001	301 37 193.8	20.08.2001	301 37 193.8	Registered
Burr-Ex	Germany	16.08.2001	301 48 669.7	28.09.2001	301 48 669.7	Registered
Novum 300	Germany	29.08.2007	307 56 670.6/07	10.01.2008	307 56 670.6	Registered
Novum 450	Germany	29.08.2007	307 56 671.4/07	10.01.2008	307 56 671.4	Registered
Peter Wolters (Logo) 	Germany	25.10.2007	307 69 698.7/03	11.04.2008	307 69 698.7	Registered
DataCare	Germany	06.11.2008	30 2008 070 614.7/07	27.05.2009	30 2008 070 614.7	Registered
	Germany	16.12.2008	30 2008 078 916.6/07	27.05.2009	30 2008 078 916.6	Registered
Planetary Pad Grinding	Germany	27.08.2009	30 2009 051 088.1/07	25.02.2010	30 2009 051 088.1	Registered
PPG	Germany	27.08.2009	30 2009 051 090.3/07	25.02.2010	30 2009 051 909.3	Registered

Trademark	Country	Filing Date	Serial No.	Reg. Date	Reg. No.	Status
	Germany	16.05.2014	30 2014 047 270.8/07	26.08.2014	30 2014 047 270	Registered
MICROSIZE	Germany	10.05.1995	39520980.3	21.03.1996	39520980	Cancelled
LAPMASTER	Hong Kong			16.03.1990	1993B03423	Abandoned
microLine	India	08.04.2008	1673923	22.02.2012	1673923	Erteilt
Peter Wolters (Logo)	India	08.04.2008	1673925	08.04.2008	1673925	Erteilt
Micron (Logo)	India	05.03.2009	1792798			Angemeldet
LAPMASTER	India	23.06.2004	1292032		23.06.2014	Registered
microLine	IR	09.04.2008	971 416	09.04.2008	971 416	Registered
Peter Wolters (Logo)	IR	22.04.2008	972 277	22.04.2008	972 277	Erteilt
	IR	16.06.2009	1 010 076	16.06.2009	1 010 076	Registered
TouchGrind	IR	11.04.2014	1 215 239	11.04.2014	1 215 239	Registered
	IR	04.08.2015	1273022	04.08.2015	1273022	Registered
LAPMASTER	Italy	30.03.2004	MI/2004/003110	10.12.2007	1082570	Registered
MICROSIZE	Japan	17.05.1995	H07-048650	29.08.1997	4050869	Cancelled
WAFERCOM	Japan	09.09.2010	2010-071086	27.05.2011	5413837	Registered
CMG	Japan	07.08.2009	2009-060309	14.05.2010	5321483	Registered
DMG	Japan	07.08.2009	2009-060310			Abandoned
PICO-FIXTURE	Japan	05.03.2009	2009-015601	30.10.2009	5276528	Registered

Trademark	Country	Filing Date	Serial No.	Reg. Date	Reg. No.	Status
LAPSTARSFT	Japan	16.02.2006	2006-013234			Abandoned
LAP STAR	Japan	16.02.2006	2006-013235			Abandoned
LASPAD	Japan	18.01.2005	2005-003044	11.25.2005	4910119	Cancelled
HYBRID SUSPENSION HEAD	Japan	02.03.2004	2004-018965	15.10.2004	4810899	Cancelled
HYBRID SUSPENSION HEAD	Japan	02.03.2004	2004-018966	17.12.2004	4825482	Cancelled
CBD DIAMOND TOISHI	Japan	02.03.2004	2004-018966	17.12.2004	4825482	Cancelled
MAIYO BATCH	Japan	22.05.2003	2003-041699	05.03.2004	4752673	Cancelled
MAIYO BATCH	Japan	22.05.2003	2003-041700	05.03.2004	4752674	Cancelled
MASAMUNE FINGER	Japan	02.09.1998	H10-074456	07.04.2000	4373127	Cancelled
WAFERCOM	Japan	02.09.1998	H10-074457	07.04.2000	4373128	Cancelled
C M G	Japan	28.07.1997	H09-141828	29.01.1999	4235174	Cancelled
DMG	Japan	05.08.1996	H08-086617	19.12.1997	4095406	Cancelled
LASLOX	Japan	12.01.1994	H06-001391	11.04.1997	3276931	Registered

Trademark	Country	Filing Date	Serial No.	Reg. Date	Reg. No.	Status
LAPOLISH	Japan	09.07.1993	H05-072672	30.08.1996	3191021	Registered
FLYCUTTER	Japan	22.04.1992	H04-105768			Abandoned
NANOCUTTER	Japan	22.04.1992	H04-105769			Abandoned
CMG	Korea	06.12.2005	40-2005-0056897	11.08.2006	4006739050000	Registered
DMG	Korea	06.12.2005	40-2005-0056899	11.08.2006	4006739100000	Registered
	Malaysia	28.08.1990	90005730			Abandoned
MICROHONE	Mexico	11.07.1995	237172	29.08.1995	501973	Registered
LAPMASTER	Singapore	13.05.2004	T0407583B			Registered
LAPMASTER	Singapore	13.05.2004	T0407584J			Registered
LAPMASTER	Singapore	13.05.2004	T0407582D			Registered
LAPMASTER	Singapore	13.05.2004	T0407587E			Registered
microLine	Taiwan	20.03.2008	97012334	01.04.2009	01357136	Erteilt
Peter Wolters (Logo)	Taiwan	22.04.2008	097018590	01.08.2011	01467361	Erteilt
LAPMASTER	Taiwan		072001047		00214535	Registered
LAPMASTER	Turkey	18.05.2004	2004/14388		2004/14388	Registered

Trademark	Country	Filing Date	Serial No.	Reg. Date	Reg. No.	Status
	U.S.	19.10.1929	71291284	04.03.1930	0267871	Cancelled
MICROSIZE	U.S.	09.12.1993	74467564	05.12.1995	1939188	Registered
BATES	U.S.	03.11.1999	75839644	24.04.2001	2445942	Registered
	U.S.	24.07.2003	76531800	18.05.2004	2842816	Cancelled
LAPMASTER	U.S.	05.09.1978	73184551	17.02.1981	1147047	Registered
LAPMASTER	U.S.	18.03.1957	72026332	23.12.1958	0671371	Registered
LAPMASTER	U.S.	18.03.1957	72026334	30.12.1958	0671714	Registered
LAPMASTER	U.S.	18.03.1957	72026333	30.09.1958	0667703	Registered
MICROHONE	U.S.	31.07.2007	77242670			Abandoned
CARLAP	UK	21.01.2004	2353942	18.06.2004	2353942	Expired

SCHEDULE 2: Patents and Patent Applications

Property right	Subject /Title	Country	Official file number	Application date	Granting date	Status
Patent	Method for machining flat workpieces	Germany	10 2008 024 125.6	6/6/2009		Published
PCT	Method for machining flat workpieces	PCT/I/R	PCT/EP2010/003028	5/18/2010		Published
European Patent	Method for machining flat workpieces	Europe	2 440 370	5/18/2010	4/3/2013	Granted
Patent	Method for machining flat workpieces	Italy	2 440 370	5/18/2010	4/3/2013	Granted
Patent	Method for machining flat workpieces	Great Britain	2 440 370	5/18/2010	4/3/2013	Granted
Patent	Method for machining flat workpieces	France	2 440 370	5/18/2010	4/3/2013	Granted
Patent	Method for machining flat workpieces	Germany	50 2010 002 864.1	5/18/2010	4/3/2013	Granted
Patent	Method for machining flat workpieces	Switzerland	2 440 370	5/18/2010	4/3/2013	Granted
Patent	Method for machining flat workpieces	Singapore	176701	5/18/2010	5/5/2014	Granted
Patent	Method for machining flat workpieces	Japan	5571776	5/18/2010	7/4/2014	Granted
Patent	Method for machining flat workpieces	China	ZL 201080032050.8	5/18/2010	11/12/2014	Granted
Patent	Method for machining flat workpieces	USA	8,951,096	3/7/2012	2/10/2015	Granted
Patent	Double-sided grinding machine	Germany	10 2010 019 203.1	5/4/2010		Published
European Patent	Double-sided grinding machine	Europe	2 384 853	5/2/2011	2/25/2015	Granted
PCT	Verfahren zum Messen der Dicke eines scheibenförmigen Werkstücks	PCT/I/R	PCT/EP2009/006275	8/29/2009		Published
Patent	Method for measuring the thickness of a discoidal workpiece	Singapore	169816	8/29/2009	8/30/2013	Granted
Patent	Method for measuring the thickness of a discoidal workpiece	South Korea	10-1311320	8/29/2009	9/16/2013	Granted
Patent	Device and method for determining the position of a working surface of a working disc	Germany	10 2010 005 032.6	1/15/2010	3/29/2012	Granted
PCT	Device and method for determining the position of a working surface of a working disc	PCT/I/R	PCT/EP2011/000043	1/7/2011		Published
European Patent	Device and method for determining the position of a working surface of a working disc	Europe	2 525 776	1/7/2011		Published
PCT	Device and Method for the Double-Sided Processing of Flat Work Pieces	PCT/I/R	PCT/EP2010/006602	10/28/2010		Published
Patent	Device and Method for the Double-Sided Processing of Flat Work Pieces	Germany	10 2009 052 070.6	11/5/2009		Published
Patent	Device and Method for the Double-Sided Processing of Flat Work Pieces	Singapore	179790	10/28/2010	10/31/2013	Granted
Patent	Device and Method for the Double-Sided Processing of Flat Work Pieces	South Korea	10-2012-7011032	10/28/2010		Published
Patent	Device and Method for the Double-Sided Processing of Flat Work Pieces	Japan	5689891	10/28/2010	2/6/2015	Granted
Patent	Method for the material-removing machining of very thin work pieces in a double side grinding machine	Germany	10 2009 015 876.2	4/1/2009		Published
PCT	Method for the material-removing machining of very thin work pieces in a double side grinding machine	PCT/I/R	PCT/EP2010/002090	4/1/2010		Published
European Patent	Method for the material-removing machining of very thin work pieces in a double side grinding machine	Europe	2 414 133	4/1/2010		Published
Patent	Method for the material-removing machining of very thin work pieces in a double side grinding machine	Singapore	174365	4/1/2010	10/31/2013	Granted
Patent	Method for the material-removing machining of very thin work pieces in a double side grinding machine	South Korea	10-2011-7023576	4/1/2010		Examination proceeding
Patent	Method for the material-removing machining of very thin work pieces in a double side grinding machine	Japan	5639147	4/1/2010	10/31/2014	Published
PCT	Device for grinding both sides of flat workpieces	PCT/I/R	PCT/EP2009/008184	11/18/2009		Published
European Patent	Device for grinding both sides of flat workpieces	Europe	2 376 257	11/18/2009	1/2/2013	Granted
Patent	Device for grinding both sides of flat workpieces	Italy	2 376 257	11/18/2009	1/2/2013	Granted
Patent	Device for grinding both sides of flat workpieces	Great Britain	2 376 257	11/18/2009	1/2/2013	Granted
Patent	Device for grinding both sides of flat workpieces	France	2 376 257	11/18/2009	1/2/2013	Granted
Patent	Device for grinding both sides of flat workpieces	Germany	50 2009 005 815.9	11/18/2009	1/2/2013	Granted
Patent	Device for grinding both sides of flat workpieces	Switzerland	2 376 257	11/18/2009	1/2/2013	Granted
Patent	Device for grinding both sides of flat workpieces	China	ZL 200980151756.3	11/18/2009	12/18/2013	Granted
Patent	Device for grinding both sides of flat workpieces	Singapore	172157	11/18/2009	10/31/2013	Granted
Patent	Device for grinding both sides of flat workpieces	South Korea	10-2011-7015853	11/18/2009		Examination proceeding
Patent	Device for grinding both sides of flat workpieces	Japan	5,360,623	11/18/2009	3/13/2013	Granted
Patent	Device for grinding both sides of flat workpieces	USA	9,004,981	06/10/2011	4/14/2015	Granted
European Patent	Method for processing workpieces in a double sided processing machine and double sided processing machine	Europe	2 199 015	11/18/2009	4/18/2012	Granted
Patent	Method for processing workpieces in a double sided processing machine and double sided processing machine	Italy	2 199 015	11/18/2009	4/18/2012	Granted
Patent	Method for processing workpieces in a double sided processing machine and double sided processing machine	Great Britain	2 199 015	11/18/2009	4/18/2012	Granted
Patent	Method for processing workpieces in a double sided processing machine and double sided processing machine	France	2 199 015	11/18/2009	4/18/2012	Granted
Patent	Method for processing workpieces in a double sided processing machine and double sided processing machine	Germany	50 2009 003 263.3	11/18/2009	4/18/2012	Granted
Patent	Method for processing workpieces in a double sided processing machine and double sided processing machine	Switzerland	2 199 015	11/18/2009	4/18/2012	Granted
European Patent	Method for operating a double sided grinding machine and double sided grinding machine	Europe	2 189 240	10/6/2009	11/23/2011	Granted
Patent	Method for operating a double sided grinding machine and double sided grinding machine	Italy	2 189 240	10/6/2009	11/23/2011	Granted
Patent	Method for operating a double sided grinding machine and double sided grinding machine	Great Britain	2 189 240	10/6/2009	11/23/2011	Granted
Patent	Method for operating a double sided grinding machine and double sided grinding machine	France	2 189 240	10/6/2009	11/23/2011	Granted
Patent	Method for operating a double sided grinding machine and double sided grinding machine	Germany	50 2009 001 981.5	10/6/2009	11/23/2011	Granted
Patent	Method for operating a double sided grinding machine and double sided grinding machine	Switzerland	2 189 240	10/6/2009	11/23/2011	Granted
Patent	Vorrichtung zur Doppelseitenbearbeitung flacher Werkstücke	Germany	10 2009 036 833.7	8/10/2009		Published
Patent	Verfahren zur Regelung des Arbeitsspals einer Doppelseitenbearbeitungsmaschine	Germany	10 2008 056 276.9	11/6/2008		Published
Patent	Machining machine with means for acquiring machining parameters	Japan	5399641	3/13/2008	11/1/2013	Granted
Patent	Machining machine with means for acquiring machining parameters	USA	7,963,823	3/12/2008	6/21/2011	Granted
Patent	Doppelseitenbearbeitungsmaschine zum Bearbeiten eines Werkstücks	Germany	10 2007 031 299.9	7/5/2007	2/28/2013	Granted
Patent	Vorrichtung und Verfahren zum chemisch-mechanischen Polieren einer Oberfläche eines Werkstücks, insbesondere eines Halbleiterwafer					
Patent	Verfahren zum Profilieren des Umfangrades einer Halbleiterschleife		10 2007 011 513.1	3/9/2007	10/23/2008	Granted
Patent	A two-side working machine	Japan	5216613	8/9/2007	3/8/2013	Granted
Patent	A two-side working machine	USA	7,357,867	1/17/2007	5/6/2008	Granted
Patent	A two-side working machine	Germany	10 2006 037 490.6	8/10/2006	4/7/2011	Granted
Patent	Double sided polishing machine	Japan	4,835,968	3/23/2005	10/7/2011	Granted
Patent	Double sided polishing machine	USA	7,101,258	4/12/2005	9/5/2006	Granted
Patent	Double sided polishing machine	Germany	10 2004 040 429.1	8/20/2004	12/17/2009	Granted
Patent	Method and apparatus for automatically loading a double-sided polishing machine with water crystals	Germany	102 28 441.5	6/26/2002	9/8/2005	Granted
Patent	Method and apparatus for automatically loading a double-sided polishing machine with water crystals	USA	6,843,704	7/8/2002	1/18/2005	Granted

Patent	Method and apparatus for automatically loading a double-sided polishing machine with wafer crystals	Japan	389462	7/10/2002	12/22/2006	Granted
Patent	Lapping machine with two plates	Germany	199 37 764.7	8/10/1999	2/16/2006	Granted
European Patent	Lapping machine with two plates	Europe	1 075 897	6/29/2000	9/13/2006	Granted
Patent	Lapping machine with two plates	Italy	1 075 897	6/29/2000	9/13/2006	Granted
Patent	Lapping machine with two plates	Great Britain	1 075 897	6/29/2000	9/13/2006	Granted
Patent	Lapping machine with two plates	France	1 075 897	6/29/2000	9/13/2006	Granted
Patent	Lapping machine with two plates	Germany	50 013 453.7	6/29/2000	9/13/2006	Granted
Patent	Lapping machine with two plates	Switzerland	1 075 897	6/29/2000	9/13/2006	Granted
Patent	Double-sided polishing machine	Japan	3,673,942	10/3/2000	5/13/2005	Granted
Patent	Apparatus for removing semiconductor wafers from within the runner disks of a double-sided polishing machine	USA	6,447,382	9/25/2000	3/10/2002	Granted
Patent	Double disk polishing machine, particularly for tooling semiconductor wafers	Japan	3,673,180	3/13/2000	11/2/2006	Granted
Patent	Double disk polishing machine, particularly for tooling semiconductor wafers	USA	6,299,514	3/10/2000	10/9/2001	Granted
Patent	Double disk polishing machine, particularly for tooling semiconductor wafers	Germany	100 07 390.5	2/18/2000	11/13/2006	Granted
Patent	Vorrichtung zur Entnahme von Halbleiterschleiben aus den Läuferschleiben in einer doppelseitigen Poliermaschine	Germany	100 07 389.1	2/18/2000	6/30/2005	Granted
Patent	Releasable Cylindrical Tool Body	USA	5,957,766	7/21/1997	9/29/1999	Granted
Patent	Integral Air Gaps for Releasable Cylindrical Tool Body	USA	6,106,383	3/31/1999	6/22/2000	Granted
Patent	Adjustable Tool Body with Fluid Actuation	USA	6,036,158	2/26/2002		Expired
PCT	Adjustable Tool Body with Fluid Actuation	USA	PCT/US03/06175	2/19/2003		Published
Patent	Adjustable Tool Body with Fluid Actuation	USA	6,739,949	7/10/2002	5/25/2004	Granted
Patent	Universal Coupling for Machine Tool	USA	6,040,694	9/3/2002		Expired
Patent	Universal Coupling for Machine Tool	USA	6,786,807	10/22/2002	10/7/2004	Granted
Patent	Machine Tool with Fluid Activated Helical Adjustment of Abrasive Elements	USA	7,070,491	4/15/2004	7/4/2006	Granted
PCT	Stamping Press	PCT	PCT/JP2012/053468	7/6/2012		Expired
Patent	Stamping Press	USA	14/412064	12/30/2014		Pending
Patent	Stamping Press	MX	MX20150000157	7/6/2012		
Patent	Illuminating Device for Machine Tool	USA	8,057,515	9/18/2013	6/18/2015	Expired

SCHEDULE 3: Lapmaster International Trademarks

Trademark	Country	Filing Date	Serial No.	Reg. Date	Reg. No.	Status
LAPMASTER	U.S.	05.09.1978	73184551	17.02.1981	1147047	Registered
LAPMASTER	U.S.	18.03.1957	72026332	23.12.1958	0671371	Registered
LAPMASTER	U.S.	18.03.1957	72026334	30.12.1958	0671714	Registered
LAPMASTER	U.S.	18.03.1957	72026333	30.09.1958	0667703	Registered

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REEL: 005974 FRAME: 0833**